FH4811

N-Channel Enhancement Mode Power MOSFET

■ Description

FH4811 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The SO-8 package is widely preferred for all commercial-industrial surface mount applications using infrared reflow technique and suited for voltage conversion or switch applications.

■ General Features

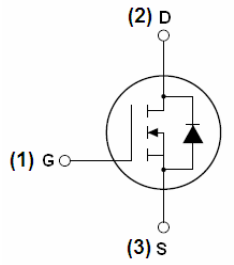
- V_{DS} = 30V , I_D =11A

  $R_{DS(ON)}$ < 11.5mΩ(MAX) @ V_{GS}=10V

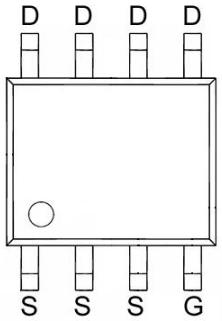
  $R_{DS(ON)}$ < 18 mΩ (MAX) @ V_{GS}=4.5V

■ Features

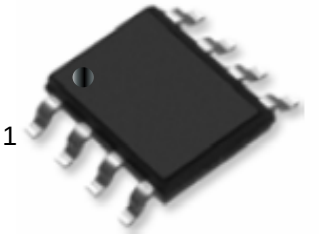
- Simple Drive Requirement
- High density cell design for ultra low Rdson
- Fast Switching Performance
- RoHS Compliant & Halogen-Free
- Fully characterized Avalanche voltage and current



Schematic diagram



Marking and pin assignment



SO-8 top view

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_A=25℃	Drain Current, V_{GS} @ 10V[3]	11	A
I_D@T_A=70℃	Drain Current, V_{GS} @ 10V[3]	8.7	A
I_{DM}	Pulsed Drain Current[1]	44	A
P_D@T_A=25℃	Total Power Dissipation	2	W
E_{AS}	Single Pulse Avalanche Energy[4]	7.2	mJ
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Value	Unit
Rthj-a	Maximum Thermal Resistance, Junction-ambient[3]	62.5	℃/W

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	30	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=10V, I_D=10A	-	8	11.5	mΩ
		V_{GS}=4.5V, I_D=5A	-	13	18	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=1mA	1	-	2	V
g_{fs}	Forward Transconductance	V_{DS}=5V, I_D=10A	-	40	-	S
I_{DSS}	Drain-Source Leakage Current	V_{DS}=24V, V_{GS}=0V	-	-	1	uA
I_{GSS}	Gate-Source Leakage	V_{GS}=±20V, V_{DS}=0V	-	-	±100	nA
Q_g	Total Gate Charge	I_D=5A	-	14	22.4	nC
Q_{gs}	Gate-Source Charge	V_{DS}=15V	-	4.4	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge	V_{GS}=4.5V	-	5.4	-	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=15V	-	9	-	ns
t_r	Rise Time	I_D=1A	-	8	-	ns
$t_{d(off)}$	Turn-off Delay Time	R_G=3.3Ω		29		ns
t_f	Fall Time	V_{GS}=10V		9		ns
C_{iss}	Input Capacitance	V_{GS}=0V	-	790	1280	pF
C_{oss}	Output Capacitance	V_{DS}=15V		225		pF
C_{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	160	-	pF
R_g	Gate Resistance	f=1.0MHz	-	2.5	5	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage[2]	I_S=1.7A, V_{GS}=0V	-	-	1.2	V
t_{rr}	Reverse Recovery Time	I_S=10A, V_{GS}=0V,	-	11	-	ns
Q_{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	4	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Surface mounted on 1 in^2 copper pad of FR4 board, t ≤10sec ; 135 ℃/W when mounted on Min. copper pad.

4.Starting T_j=25°C , V_{DD}=30V , L=0.1mH , R_G=25Ω

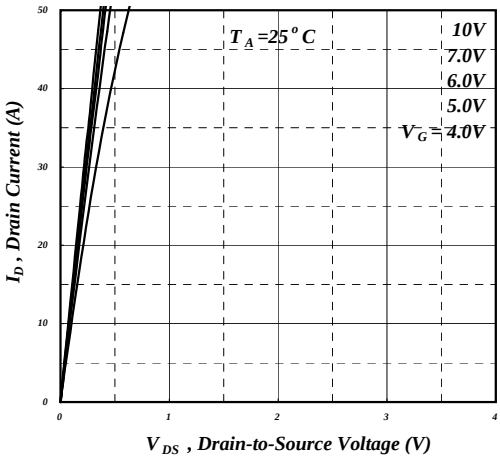


Fig 1. Typical Output Characteristics

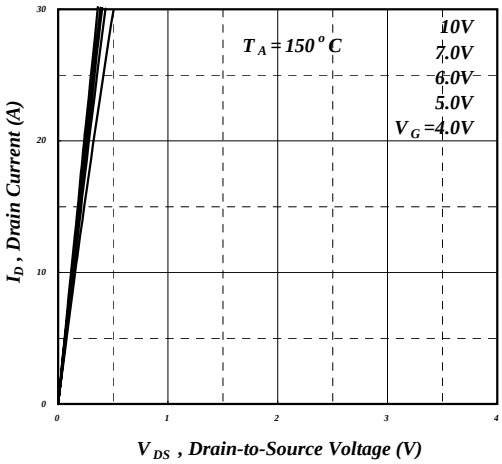


Fig 2. Typical Output Characteristics

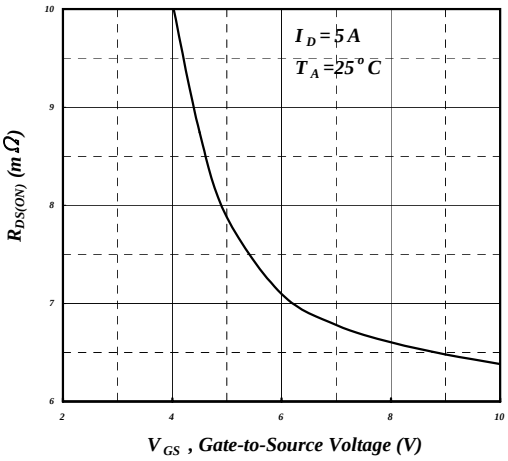


Fig 3. On-Resistance v.s. Gate Voltage

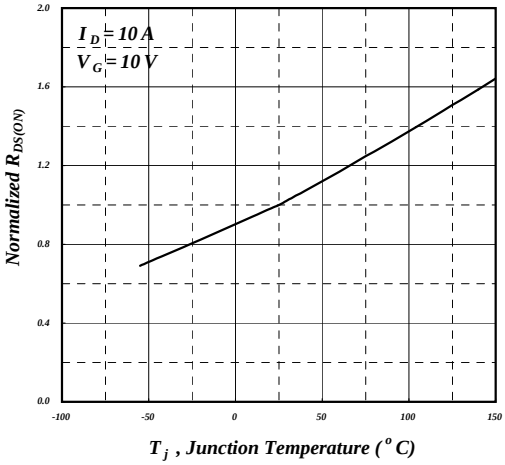


Fig 4. Normalized On-Resistance v.s. Junction Temperature

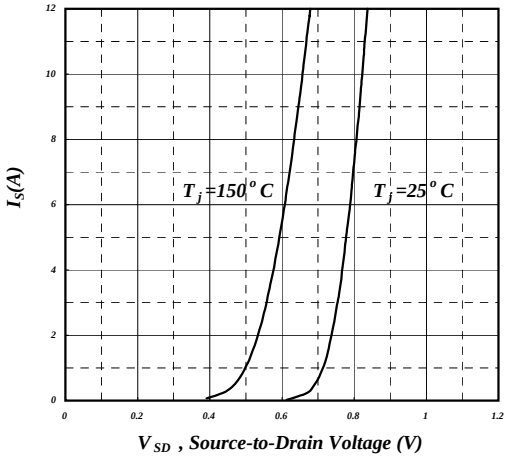


Fig 5. Forward Characteristic of Reverse Diode

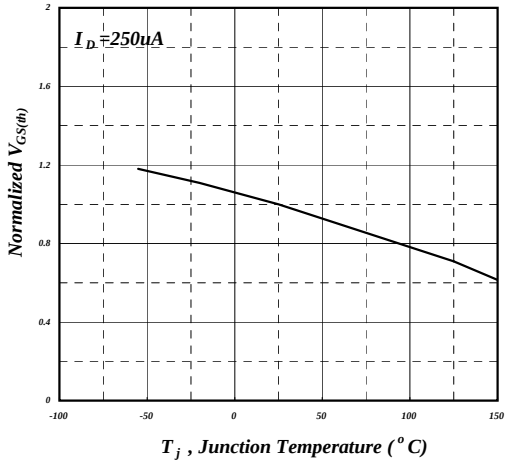


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

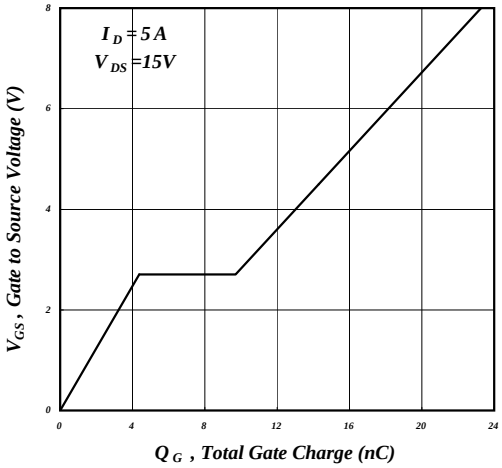


Fig 7. Gate Charge Characteristics

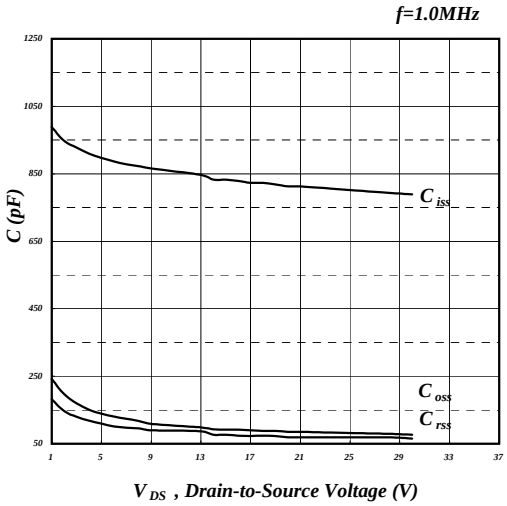


Fig 8. Typical Capacitance Characteristics

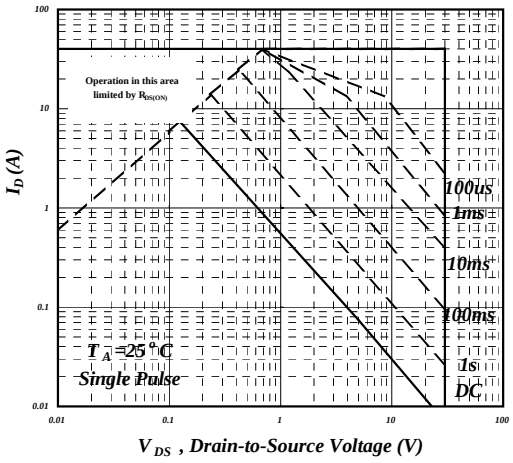


Fig 9. Maximum Safe Operating Area

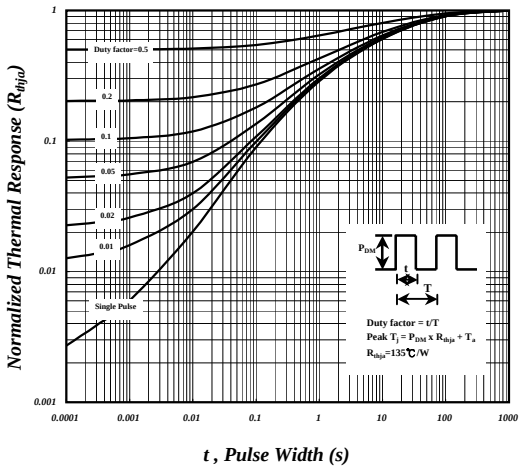


Fig 10. Effective Transient Thermal Impedance

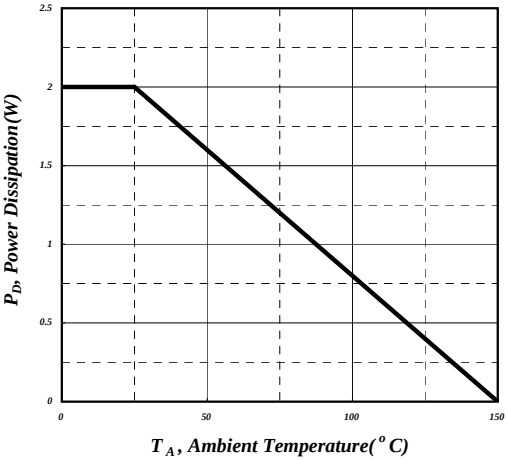


Fig 11. Total Power Dissipation

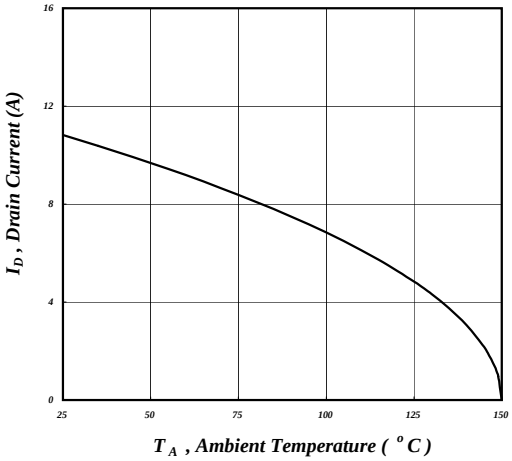
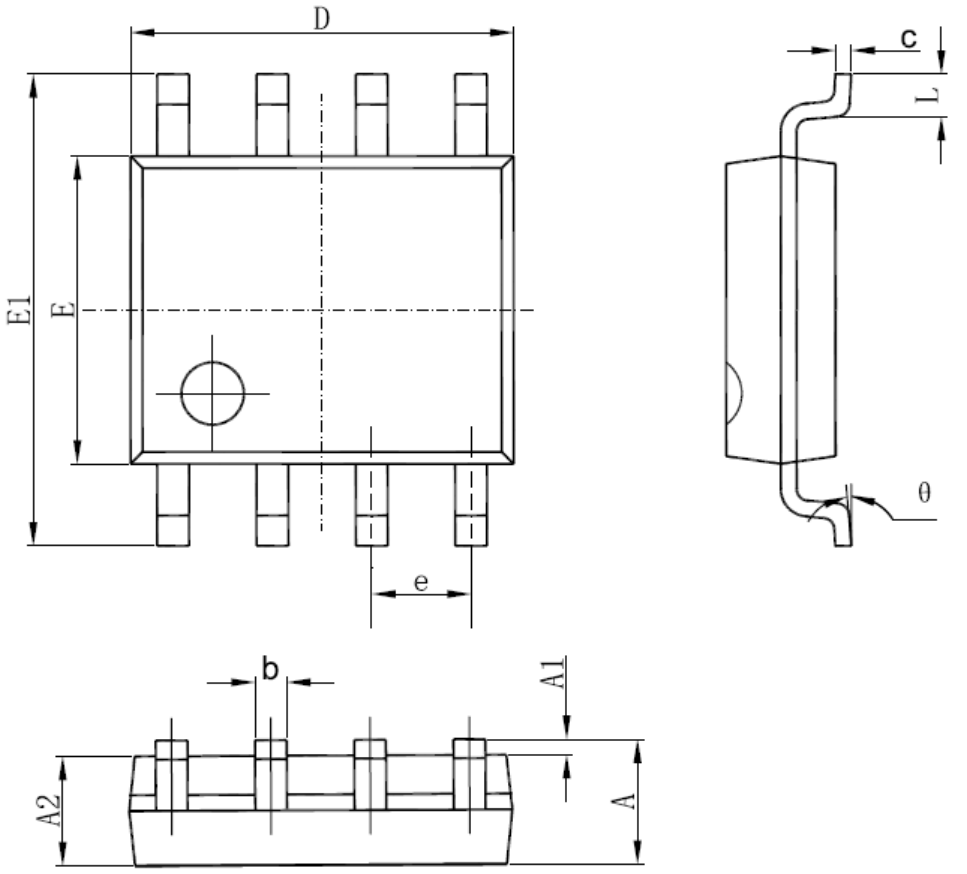


Fig 12. Drain Current v.s. Ambient Temperature

Package Information ：SO-8



SYMBOL	MM		INCH		SYMBOL	MM		INCH	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	1.350	1.750	0.053	0.069	E	3.800	4.000	0.150	0.157
A1	0.100	0.250	0.004	0.010	E1	5.800	6.200	0.228	0.244
A2	1.350	1.550	0.053	0.061	e	1.270 (BSC)		0.050 (BSC)	
b	0.330	0.510	0.013	0.020	L	0.400	1.270	0.016	0.050
c	0.170	0.250	0.006	0.010	θ	0°	8°	0°	8°
D	4.700	5.100	0.185	0.200					

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